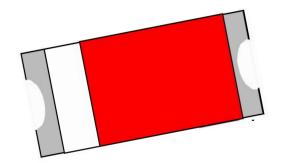
2.4GHz 5221 Chip Antenna: RANT5221F245M02

1. Applications

WLAN, 802.11b/g, Bluetooth, WLAN, etc...



2. Features

SMD, high reliability, ultra Impact, Omni-directional...

3. Part Number Information

<u>RANT</u>	<u>5221</u>	<u>F</u>		<u>245</u>	<u>M</u>	<u>02</u>
(A)	(B)	(C)	(D)	(E)	(F)
(A)Product	Туре		Ch	ip Anten	ina	
(B) Size Co	de		5.0	x2.0mm	(±0.2mm	1)

(7 t)1 Todaot Typo	omp / moma
(B) Size Code	5.0x2.0mm(±0.2mm)
(C) Material	High K material
(D) Frequency	2.4 ~ 2.5GHz
(E) Feeding mode	PIFA & Single Feeding
(F) Antenna type	Type=02

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4. 产品尺寸

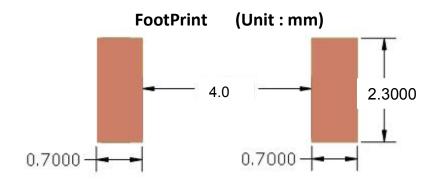
monopole antenna

Figure	Symbol	Dimension (mm)
L	L (长)	5.00 ± 0.20
w	W (宽)	2.00 ± 0.30
	T (厚度)	1.0 ± 0.30
A	A (电极宽度)	0.50± 0.20

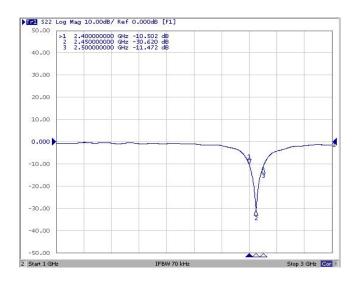
5. Electrical Specification

Spec	cification		
Part Number	RANT 5221 F245 M0	2	
Central Frequency	2450	MHz	
Bandwidth	120 (Min.)	MHz	
Return Loss	-10 (Max)	dB	
Peak Gain	3.59	dBi	
Impedance	50	Ohm	
Operating Temperature	-40∼+85	$^{\circ}\!\mathbb{C}$	
Maximum Power	4	W	
Resistance to Soldering Heats	10 (@ 260°C)	sec.	
Polarization	Linear		
Azimuth Beamwidth	Omni-directional		
Termination	Sn (Leadless)		

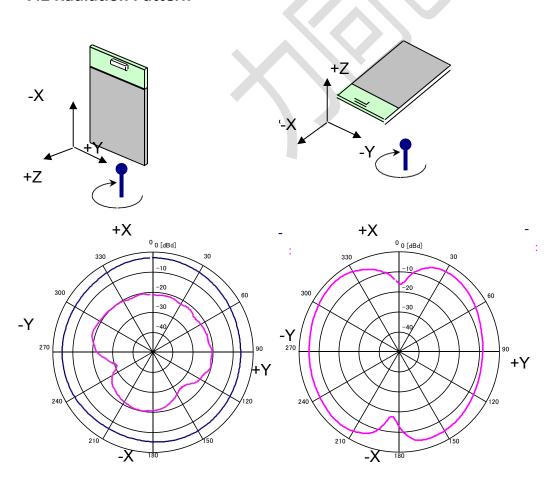
6. PCB



7. Measurement Results Return Loss



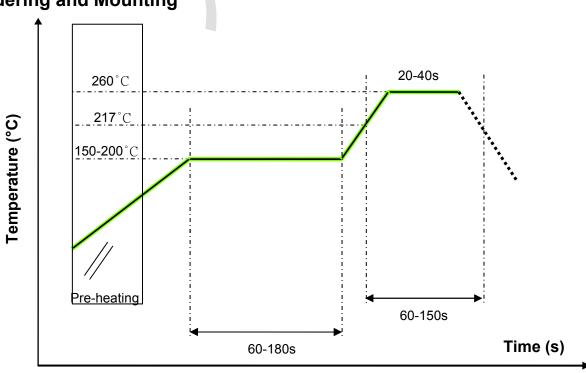
7.2 Radiation Pattern



8. Reliability and Test Condictions

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature: 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature: $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time: $30 \pm 0.5 \text{ sec}$ Solder: SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
313 C 0031- 7.4.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	
Resistance to soldering heat	*Preheating temperature ∶ 120~150°C,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
0.00000.1	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
	Solder : Sn3Ag0.5Cu for lead-free	~ 85°C.
	Measurement to be made after keeping at	Loss of metallization on the edges of each
	room temperature for 24±2 hrs	electrode shall not exceed 25%.

9. Soldering and Mounting



10. Storage and Transportation Information

Storage Conditions

To maintain the solderability of terminal electrodes:

- 1. Temperature and humidity conditions: -10~ 40°C and 30~70% RH.
- 2. Recommended products should be used within 6 months from the time of delivery.
- 3. The packaging material should be kept where no chlorine or sulfur exists in the air.

Transportation Conditions

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

11. Packing

P

- (1) Quantity/Reel: 2000 pcs/Reel
- (2) Plastic tape:

a. Tape Drawing

b. Tape Dimensions (unit: mm)

Feature	Specifications	Tolerances
W	12.00	±0.30
Р	4.00	±0.10
Е	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 -0.00
Po	4.00	±0.10
10Po	40.00	±0.20

c. Reel Drawing

